# **ON Semiconductor**

## Is Now



To learn more about onsemi™, please visit our website at www.onsemi.com

onsemi and ONSEMI. and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/ or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application,

# MOSFET - Power, N-Channel, SUPERFET® III, FAST

650 V, 95 mΩ, 30 A

# NTP095N65S3H

#### **Description**

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provides superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III FAST MOSFET series helps minimize various power systems and improve system efficiency.

#### **Features**

- $700 \text{ V} @ \text{T}_{\text{J}} = 150^{\circ}\text{C}$
- Typ.  $R_{DS(on)} = 77 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ.  $Q_g = 58 \text{ nC}$ )
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 522 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

#### **Applications**

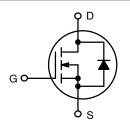
- Telecom / Server Power Supplies
- Industrial Power Supplies
- UPS / Solar



#### ON Semiconductor®

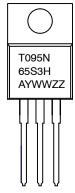
#### www.onsemi.com

| V <sub>DSS</sub> | R <sub>DS(ON)</sub> MAX | I <sub>D</sub> MAX |  |  |
|------------------|-------------------------|--------------------|--|--|
| 650 V            | 95 mΩ @ 10 V            | 30 A               |  |  |





#### **MARKING DIAGRAM**



T095N65S3H

= Specific Device Code

A YWW = Assembly Plant Code= Date Code (Year & Week)

**7**Z

= Lot Code

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

#### **ABSOLUTE MAXIMUM RATINGS** ( $T_C = 25^{\circ}C$ , Unless otherwise noted)

| Symbol                            | Parameter  |                                     | Value       | Unit |  |
|-----------------------------------|--|-------------------------------------|-------------|------|--|
| $V_{DSS}$                         | Drain to Source Voltage  |                                     | 650         | V    |  |
| $V_{GSS}$                         | Gate to Source Voltage   | DC                                  | ±30         | V    |  |
|                                   |  | AC (f > 1 Hz)                       | ±30         | V    |  |
| I <sub>D</sub>                    | Drain Current  | Continuous (T <sub>C</sub> = 25°C)  | 30          | А    |  |
|                                   |  | Continuous (T <sub>C</sub> = 100°C) | 18          |      |  |
| I <sub>DM</sub>                   | Drain Current  | Pulsed (Note 1)                     | 84          | Α    |  |
| E <sub>AS</sub>                   | Single Pulsed Avalanche Energy (Note 2)                        |                                     | 284         | mJ   |  |
| I <sub>AS</sub>                   | Avalanche Current (Note 2)                                     |                                     | 5.5         | Α    |  |
| E <sub>AR</sub>                   | Repetitive Avalanche Energy (Note 1)                           |                                     | 2.08        | mJ   |  |
| dv/dt                             | MOSFET dv/dt   |                                     | 120         | V/ns |  |
|                                   | Peak Diode Recovery dv/dt (Note 3)                             |                                     | 20          |      |  |
| $P_{D}$                           | Power Dissipation  | (T <sub>C</sub> = 25°C)             | 208         | W    |  |
|                                   |  | Derate Above 25°C                   | 1.67        | W/°C |  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature Range                        |                                     | -55 to +150 | °C   |  |
| TL                                | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 s |                                     | 260         | °C   |  |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 5.5 \text{ A}$ ,  $R_{G} = 25 \Omega$ , starting  $T_{J} = 25^{\circ}\text{C}$ . 3.  $I_{SD} \le 15 \text{ A}$ ,  $di/dt \le 200 \text{ A/µs}$ ,  $V_{DD} \le 400 \text{ V}$ , starting  $T_{J} = 25^{\circ}\text{C}$ .

#### THERMAL CHARACTERISTICS

| Symbol         | Parameter                                     | Value | Unit |
|----------------|---|-------|------|
| $R_{	heta JC}$ | Thermal Resistance, Junction to Case, Max.    | 0.60  | °C/W |
| $R_{	heta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 62.5  |      |

#### PACKAGE MARKING AND ORDERING INFORMATION

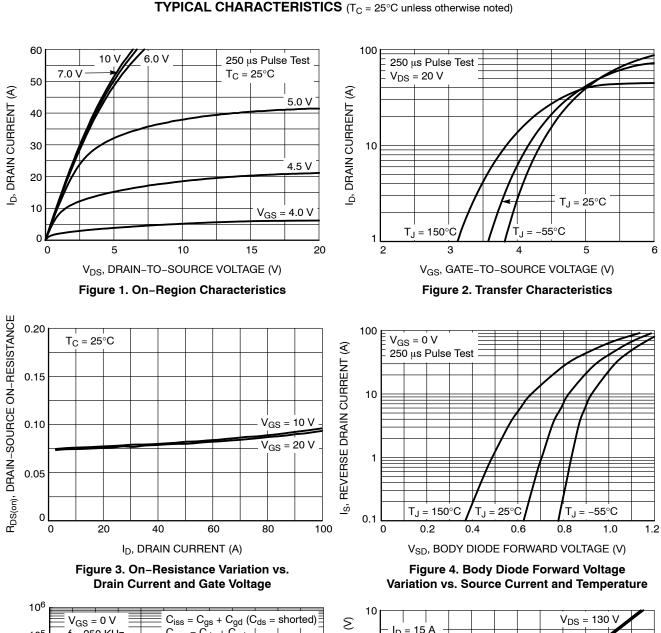
| Part Number  | Top Marking | Package                                | Shipping        |
|--------------|-------------|--|-----------------|
| NTP095N65S3H | T095N65S3H  | TO-220-3LD<br>(Pb-Free / Halogen Free) | 50 Units / Tube |

### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

| Symbol                         | Parameter  | Test Conditions  | Min | Тур  | Max  | Unit |
|--------------------------------|--|--|-----|------|------|------|
| OFF CHARACT                    | ERISTICS   |  |     |      | •    | •    |
| BV <sub>DSS</sub>              | Drain to Source Breakdown Voltage                        | $V_{GS} = 0 \text{ V, } I_D = 1 \text{ mA, } T_J = 25^{\circ}\text{C}$                   | 650 |      |      | V    |
|                                |  | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 150°C                     | 700 |      |      | V    |
| $\Delta BV_{DSS}/\Delta T_{J}$ | Breakdown Voltage Temperature<br>Coefficient             | I <sub>D</sub> = 10 mA, Referenced to 25°C   |     | 0.63 |      | V/°C |
| I <sub>DSS</sub>               | Zero Gate Voltage Drain Current                          | V <sub>DS</sub> = 650 V, V <sub>GS</sub> = 0 V   |     |      | 1    | μΑ   |
|                                |  | V <sub>DS</sub> = 520 V, T <sub>C</sub> = 125°C  |     | 1.8  |      |      |
| I <sub>GSS</sub>               | Gate to Body Leakage Current                             | V <sub>GS</sub> = ±30 V, V <sub>DS</sub> = 0 V   |     |      | ±100 | nA   |
| ON CHARACTE                    | RISTICS  |  | -   |      | •    | •    |
| V <sub>GS(th)</sub>            | Gate Threshold Voltage                                   | $V_{GS} = V_{DS}, I_D = 2.8 \text{ mA}$  | 2.4 |      | 4.0  | V    |
| R <sub>DS(on)</sub>            | Static Drain to Source On Resistance                     | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A  |     | 77   | 95   | mΩ   |
| 9FS                            | Forward Transconductance                                 | V <sub>DS</sub> = 20 V, I <sub>D</sub> = 15 A  |     | 30   |      | S    |
| DYNAMIC CHA                    | RACTERISTICS   |  | •   | •    |      | •    |
| C <sub>iss</sub>               | Input Capacitance  | V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 0 V, f = 250 kHz                              |     | 2833 |      | pF   |
| C <sub>oss</sub>               | Output Capacitance                                       |  |     | 43   |      | pF   |
| C <sub>oss(eff.)</sub>         | Effective Output Capacitance                             | V <sub>DS</sub> = 0 V to 400 V, V <sub>GS</sub> = 0 V                                    |     | 522  |      | pF   |
| C <sub>oss(er.)</sub>          | Energy Related Output Capacitance                        | V <sub>DS</sub> = 0 V to 400 V, V <sub>GS</sub> = 0 V                                    |     | 75   |      | pF   |
| Q <sub>g(tot)</sub>            | Total Gate Charge at 10 V                                |  |     | 58   |      | nC   |
| Q <sub>gs</sub>                | Gate to Source Gate Charge                               | V <sub>DS</sub> = 400 V, I <sub>D</sub> = 15 A, V <sub>GS</sub> = 10 V<br>(Note 4)       |     | 14   |      | nC   |
| $Q_{gd}$                       | Gate to Drain "Miller" Charge                            |  |     | 15   |      | nC   |
| ESR                            | Equivalent Series Resistance                             | f = 1 MHz  |     | 1.2  |      | Ω    |
| SWITCHING CH                   | IARACTERISTICS   |  |     |      |      |      |
| t <sub>d(on)</sub>             | Turn-On Delay Time                                       |  |     | 24   |      | ns   |
| t <sub>r</sub>                 | Turn-On Rise Time  | $V_{DD} = 400 \text{ V}, I_D = 15 \text{ A},$  |     | 7.4  |      | ns   |
| t <sub>d(off)</sub>            | Turn-Off Delay Time                                      | $V_{DD}$ = 400 V, $I_{D}$ = 15 A,<br>$V_{GS}$ = 10 V, $R_{g}$ = 4.7 $\Omega$<br>(Note 4) |     | 69   |      | ns   |
| t <sub>f</sub>                 | Turn-Off Fall Time                                       |  |     | 2.4  |      | ns   |
| SOURCE-DRAI                    | N DIODE CHARACTERISTICS                                  |  | -   |      | •    |      |
| I <sub>S</sub>                 | Maximum Continuous Source to Drain Diode Forward Current |  |     |      | 30   | Α    |
| I <sub>SM</sub>                | Maximum Pulsed Source to Drain Diode Forward Current     |  |     |      | 84   | Α    |
| V <sub>SD</sub>                | Source to Drain Diode Forward Voltage                    | V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 15 A  |     |      | 1.2  | ٧    |
| t <sub>rr</sub>                | Reverse Recovery Time                                    | V <sub>DD</sub> = 400 V, I <sub>SD</sub> = 15 A,   |     | 367  |      | ns   |
| Q <sub>rr</sub>                | Reverse Recovery Charge                                  | dl <sub>F</sub> /dt = 100 A/μs   |     | 6.3  |      | μС   |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.



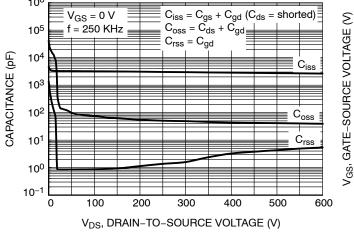


Figure 5. Capacitance Characteristics

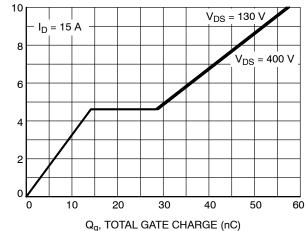


Figure 6. Gate Charge Characteristics

#### TYPICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

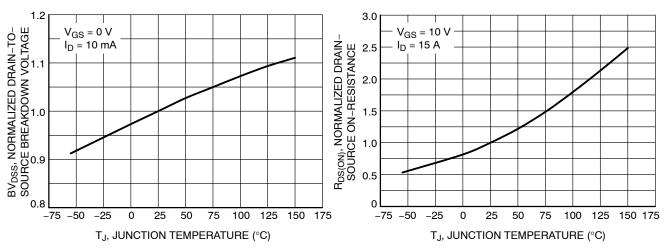


Figure 7. Breakdown Voltage Variation vs. Temperature

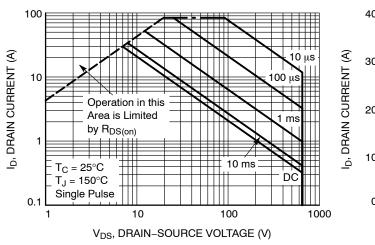


Figure 9. Maximum Safe Operating Area



V<sub>DS</sub>, DRAIN-TO-SOURCE VOLTAGE (V) Figure 11. E<sub>OSS</sub> vs. Drain to Source Voltage

Figure 8. On-Resistance Variation vs. Temperature

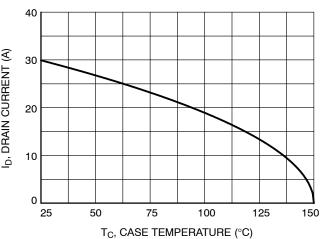


Figure 10. Maximum Drain Current vs. Case Temperature

# **TYPICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

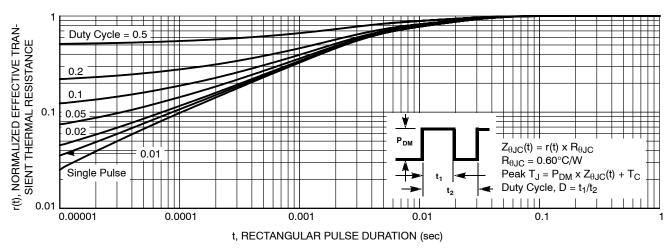


Figure 12. Transient Thermal Impedance

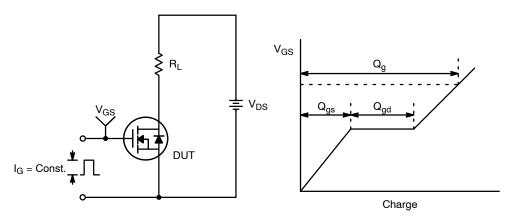


Figure 13. Gate Charge Test Circuit & Waveform

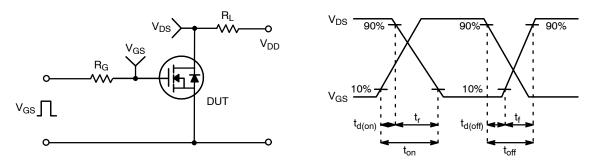


Figure 14. Resistive Switching Test Circuit & Waveforms

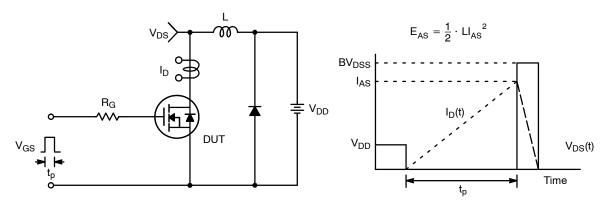


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

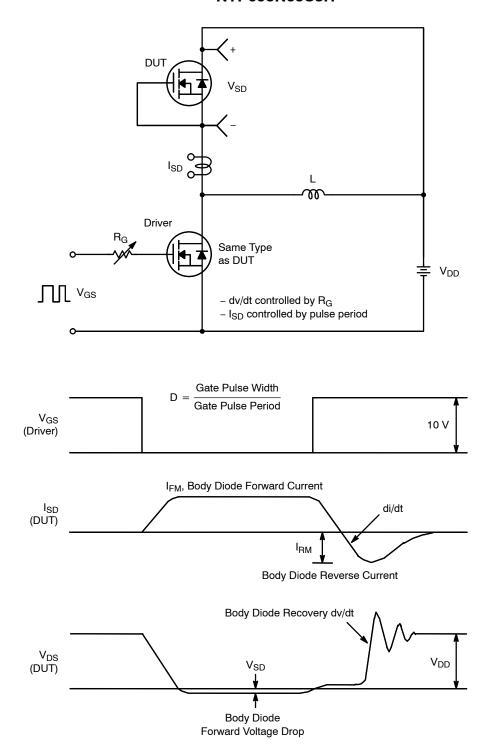
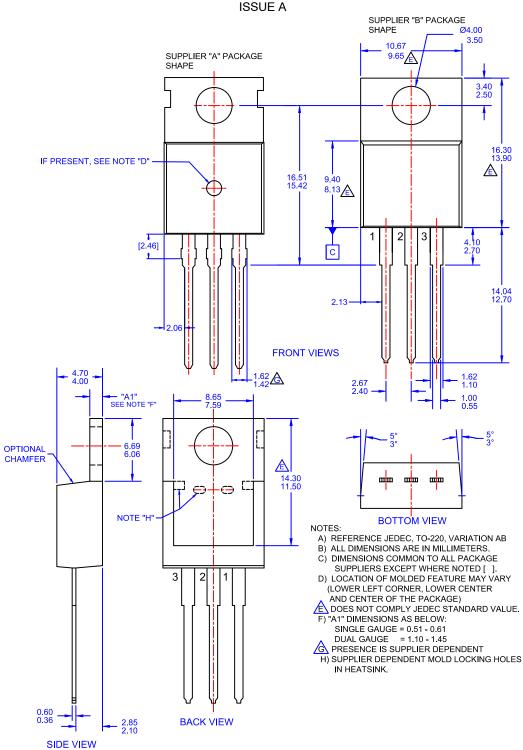


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

SUPERFET is a registered trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.

#### **PACKAGE DIMENSIONS**

# **TO-220-3LD**CASE 340AT



ON Semiconductor and (III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability. arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages.

Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### **PUBLICATION ORDERING INFORMATION**

LITERATURE FULFILLMENT: Email Requests to: orderlit@onsemi.com

ON Semiconductor Website: www.onsemi.com

TECHNICAL SUPPORT

North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

614233C 648584F IRFD120 JANTX2N5237 FCA20N60\_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B